

Technical Notice

Issue Date: Jan 2, 2017

Product Name: IEI Skylake/Braswell product

Implementation Date: Jan 2, 2017

This notice is to inform you of changes to the IEI Skylake/Braswell product.

Reason for Change

Due to the chipset limitation, Intel Skylake and Braswell platform require USB 3.0 drivers to be preloaded in order to use USB devices during Windows 7 installation

Description of Change

To solve USB devices cannot work normally while installing windows 7 under Skylake/ Braswell platform. Please follow the link below to create image for Win 7 installation.

<https://downloadcenter.intel.com/download/25476/Windows-7-USB-3-0-Creator-Utility>

Windows 7 SP1 OS	
Starter 32bit	Ultimate 32bit
Home Basic 32bit	Enterprise 64bit
Home Premium 32bit	Home Premium 64bit
Professional 32bit	Professional 64bit
	Ultimate 64bit

To those which not on the list, please follow the link below to mount USB3.0 driver and OS image into a package.

Affected Model

Affected Model	
Skylake	
SPCIE-C236-i2-R10	SPCIE-C236-R10
HPCIE-C236-R10	HPCIE-Q170-R10
PCIE-Q170-i2-R10	PCIE-Q170-R10
IMBA-C2360-i2-R10	IMBA-H110-R10
IMBA-H110-ECO-R10	IMBA-Q170-i2-R10

IMBA-Q170-ECO-R10	IMB-H110-R10
IMB-H110-ECO-R10	KINO-AQ170-R10
KINO-DCM236-E3-R10	KINO-DCM236-E3E-R10
KINO-DCM236-i3E-R10	KINO-DCM236-CE-R10
KINO-DQM170-i7-R10	KINO-DQM170-i5-R10
KINO-DQM170-i3E-R10	KINO-DQM170-CE-R10
NANO-ULT3-CE-R10	NANO-ULT3-i7-R10
NANO-ULT3-i5-R10	NANO-ULT3-i3-R10
NANO-ULT3-C-R10	ICE-ULT3-CE-R10
ICE-ULT3-i7-R10	ICE-ULT3-i5-R10
ICE-ULT3-i3-R10	ICE-ULT3-C-R10
TANK-870-Q170i-i5/4G/2A-R10	TANK-870-Q170i-i5/4G/2B-R10
TANK-870-Q170i-i5/4G/4A-R10	TANK-870-Q170i-i5/4G/4B-R10
TANK-870-Q170i-i7/4G/2A-R10	TANK-870-Q170i-i7/4G/2B-R10
TANK-870-Q170i-i7/4G/4A-R10	TANK-870-Q170i-i7/4G/4B-R10
Braswell Product	
tKINO-BW-N4-R10	tKINO-BW-N3-R10
tKINO-BW-N2-R10	tKINO-BW-N1-R10
WAFER-BW-N4-R10	WAFER-BW-N3-R10
WAFER-BW-N2-R10	WAFER-BW-N1-R10
HYPER-BW-N4-R10	HYPER-BW-N3-R10
HYPER-BW-N2-R10	HYPER-BW-N1-R10
TANK-610-BW-N3/2G-R10	uIBX-250-BW-N3/2G-R10
IDS-300-BW-N3/4G-R10	

Affected by This Change

- | | | | |
|--|-------------------------------------|-------------------------------------|--|
| <input checked="" type="checkbox"/> Specifications | <input type="checkbox"/> Dimensions | <input type="checkbox"/> Appearance | <input type="checkbox"/> Package |
| <input type="checkbox"/> Certification | <input type="checkbox"/> Label | <input type="checkbox"/> BIOS | <input checked="" type="checkbox"/> Driver |

For more details please refer to the latest datasheet or visit <http://www.ieiworld.com>.

Best Regards,
Jason Kao
Project Manager
IEI Integration Corp.

Technical Notice

Issue Date: January 12, 2021

Product Name: ICE-ULT3 products.

Implementation Date: January 12, 2021

Implementation Type: Running Change

This notice is to inform you of changes to the
Computer on Module: ICE-ULT3 series

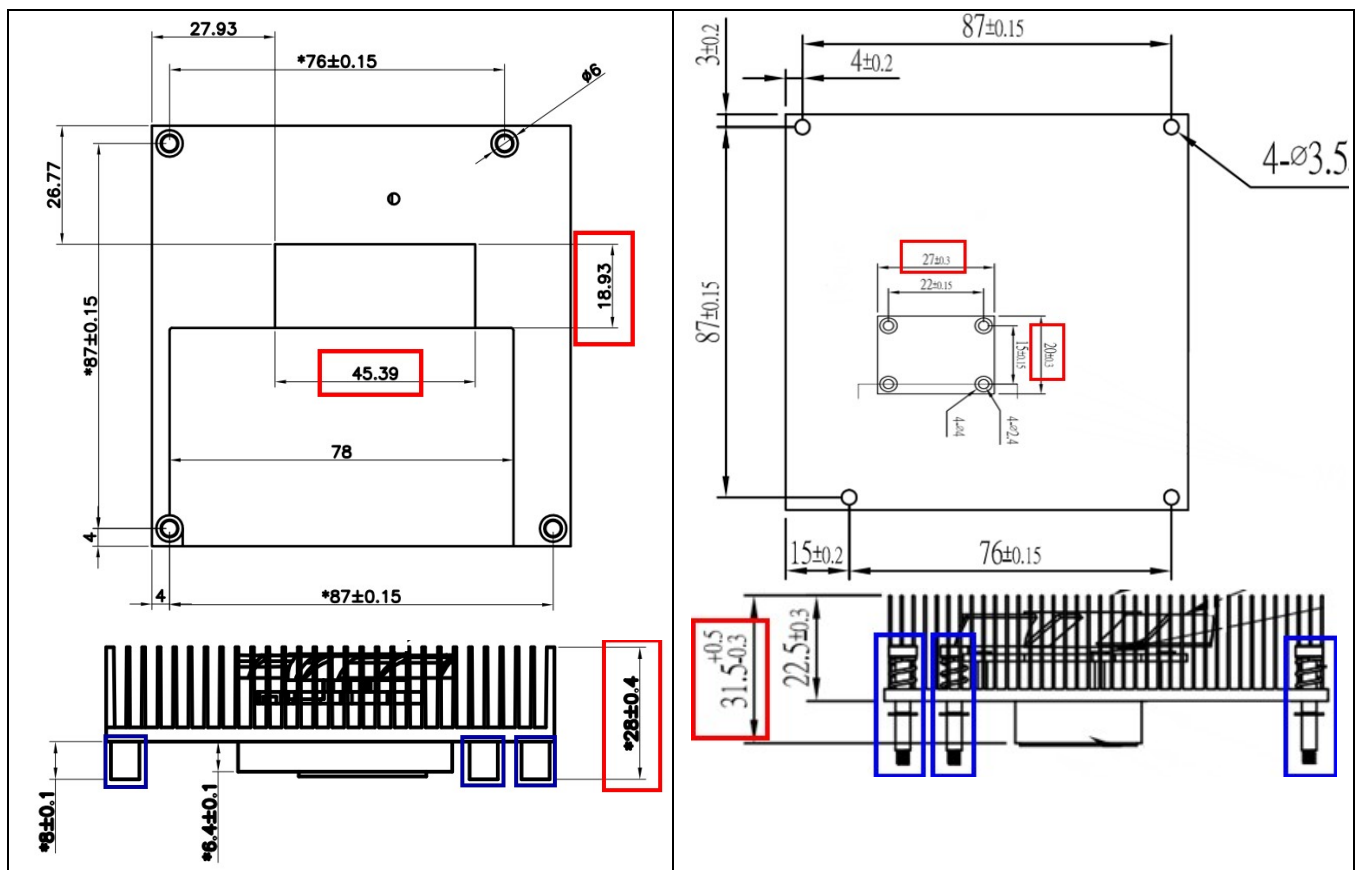
Reason for Change

The heat sink of ICE-ULT3 is EOL. IEI will start transitioning the heat sink of the related products from 19100-000221-00-RS to 19100-000235-00-RS.

Description of Change

Change the heat sink from 19100-000221-00-RS to 19100-000235-00-RS.

PN: 19100-000221-00-RS	PN: 19100-000235-00-RS



Affected Model

Affected Model	
ICE-ULT3-C-R10	
ICE-ULT3-i3-R10	
ICE-ULT3-i7-R10	

Affected by This Change

- | | | | |
|---|--|--|---|
| <input type="checkbox"/> Specifications | <input checked="" type="checkbox"/> Dimensions | <input checked="" type="checkbox"/> Appearance | <input checked="" type="checkbox"/> Package |
| <input type="checkbox"/> Certification | <input type="checkbox"/> Label | <input type="checkbox"/> BIOS | <input type="checkbox"/> Driver |

For more details please refer to the latest datasheet or visit <http://www.ieiworld.com>.

Best Regards,
Kasper Tsai
Product Manager
IEI Integration Corp.